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Dual D-Type Flip-Flop with **Preset and Clear**

MM74HC74A

The MM74HC74A utilizes advanced silicon-gate CMOS technology to achieve operating speeds similar to the equivalent LS-TTL part. It possesses the high noise immunity and low power consumption of standard CMOS integrated circuits, along with the ability to drive 10 LS-TTL loads.

This flip-flop has independent data, preset, clear, and clock inputs and Q and \overline{Q} outputs. The logic level present at the data input is transferred to the output during the positive-going transition of the clock pulse. Preset and clear are independent of the clock and accomplished by a low level at the appropriate input.

The 74HC logic family is functionally and pinout compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Features

- Typical Propagation Delay: 12 ns
- Wide Power Supply Range: 2 V 6 V
- Low Quiescent Current: 80 µA maximum (74HC Series)
- Low Input Current: 1 µA Maximum
- Fanout of 10 LS-TTL Loads

Connection Diagram

• These Devices are Pb-Free, Halide Free and are RoHS Compliant

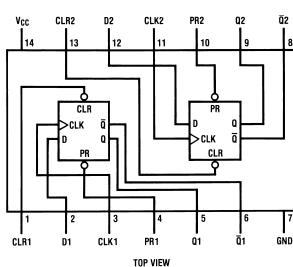
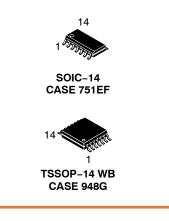
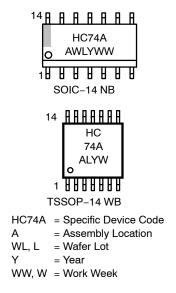


Figure 1. Pin Assignments for SOIC and TSSOP



MARKING DIAGRAM



TRUTH TABLE

	Inp	Outputs			
PR	CLR	CLK	D	Q	Q
L	Н	Х	Х	Н	L
Н	L	Х	Х	L	Н
L	L	Х	Х	Н	Н
				(Note1)	(Note1)
Н	Н	↑	Н	Н	L
Н	Н	↑	L	L	Н
Н	Н	L	Х	Q0	Q0

Q0 = the level of Q before the indicated input conditions were established.

1. This configuration is nonstable; that is, it will not persist when preset and clear inputs return to their inactive (HIGH) level.

ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

Logic Diagram

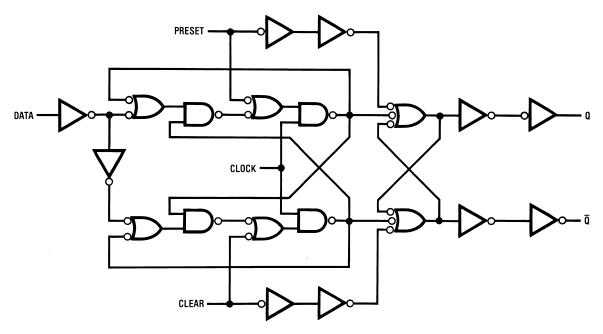


Figure 2. Logic Diagram

MAXIMUM RATINGS (Note 2)

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	–0.5 to +6.5 V
V _{IN}	DC Input Voltage	–0.5 to V _{CC} + 0.5 V
V _{OUT}	DC Output Voltage	–0.5 to V _{CC} + 0.5 V
I _{IK} , I _{OK}	Clamp Diode Current	±20 mA
I _{OUT}	DC Output Current, per Pin	±25 mA
Icc	DC V _{CC} or GND Current, per Pin	±50 mA
T _{STG}	Storage Temperature Range	–65°C to +150°C
PD	Power Dissipation SOIC-14 TSSOP-14	1077 mW 833 mW
ΤL	Lead Temperature (Soldering 10 Seconds)	260°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

2. Unless otherwise specified all voltages are referenced to ground.

RECOMMENDED OPERATING CONDITIONS

Symbol		Min	Max	Unit	
V _{CC}	Supply Voltage	2	6	V	
V _{IN} , V _{OUT}	DC Input or Output Voltage	0	V _{CC}	V	
T _A	Operating Temperature Range			+125	°C
t _r , t _f	Input Rise or Fall Times	-	1000	ns	
		V _{CC} = 4.5 V		500	ns
		V _{CC} = 6.0 V	_	400	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

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DC CHARACTERISTICS (Note 3)

				T _A =	25°C	T _A = −40°C to 85°C	T _A = −55°C to 125°C	
Symbol	Parameter	V _{CC} (V)	Conditions	Тур	0	Guaranteed Li	uaranteed Limits	
V _{IH}	Minimum HIGH Level Input	2.0		-	1.5	1.5	1.5	V
	Voltage	4.5		-	3.15	3.15	3.15	
		6.0		_	4.2	4.2	4.2	
VIL	Maximum LOW Level Input	2.0		-	0.5	0.5	0.5	V
	Voltage	4.5		-	1.35	1.35	1.35	
		6.0		-	1.8	1.8	1.8	
V _{OH}	Minimum HIGH Level Output Voltage	2.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$	2.0	1.9	1.9	1.9	V
Voltage		4.5	I _{OUT} ≤ 20 μΑ	4.5	4.4	4.4	4.4	
		6.0		6.0	5.9	5.9	5.9	
		4.5	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 4.0 \text{ mA}$	4.3	3.98	3.84	3.7	
		6.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \leq 5.2 \text{ mA}$	5.2	5.48	5.34	5.2	
V _{OL}	Maximum LOW Level Output	2.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$	0	0.1	0.1	0.1	V
	Voltage	4.5	I _{OUT} ≤ 20 μΑ	0	0.1	0.1	0.1	
		6.0		0	0.1	0.1	0.1	
		4.5	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 4.0 \text{ mA}$	0.2	0.26	0.33	0.4	
		6.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 5.2 \text{ mA}$	0.2	0.26	0.33	0.4	
I _{IN}	Maximum Input Current	6.0	V _{IN} = V _{CC} or GND	-	±0.1	±1.0	±1.0	μA
I _{CC}	Maximum Quiescent Supply Current	6.0	V_{IN} = V_{CC} or GND, I_{OUT} = 0 μ A	-	4.0	40	80	μA

3. For a power supply of 5 V \pm 10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5 V. Thus the 4.5 V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5 V and 4.5 V respectively. (The V_{IH} value at 5.5 V is 3.85 V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0 V values should be used.

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Unit
f _{MAX}	Maximum Operating Frequency		72	30	MHz
t _{PHL} , t _{PLH}	Maximum Propagation Delay, Clock to Q or \overline{Q}		10	30	ns
t _{PHL} , t _{PLH}	Maximum Propagation Delay, Preset or Clear to Q or $\overline{\mathbf{Q}}$		17	40	ns
t _{REM}	Minimum Removal Time, Preset or Clear to Clock		6	5	ns
t _s	Minimum Setup Time, Data to Clock		10	20	ns
t _H	Minimum Hold Time, Clock to Data		0	0	ns
t _W	Minimum Pulse Width Clock, Preset or Clear		8	16	ns

AC CHARACTERISTICS (V_{CC} = 5 V, T_A = 25^{\circ}C, C_L = 15 \text{ pF}, t_r = t_f = 6 \text{ ns})

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				T _A =	25°C	T _A = −40°C to 85°C	T _A = −55°C to 125°C		
Symbol	Parameter	V _{CC} (V)	Conditions	Тур	(Guaranteed Li	mits	Unit	
f _{MAX}	Maximum Operating Frequency	2.0		22	6	5	4	ns	
		4.5		72	30	24	20		
		6.0		94	35	28	24		
t _{PHL} , t _{PLH}	Maximum Propagation Delay,	2.0		34	110	140	165	ns	
	Clock to Q or \overline{Q}	4.5		12	22	28	33		
		6.0		10	19	24	28		
t _{PHL} , t _{PLH}	Maximum Propagation Delay,	2.0		66	150	190	225	ns	
	Preset or Clear to Q or \overline{Q}	4.5		20	30	38	45		
		6.0		16	26	33	38		
t _{REM}	Minimum Removal Time, Preset or Clear to Clock	2.0		20	50	65	75	ns	
		4.5		6	10	13	15		
		6.0		5	9	11	13		
t _s	Minimum Setup Time, Data to Clock	2.0		35	80	100	120	ns	
		4.5		10	16	20	24		
		6.0		8	14	17	20		
t _H	Minimum Hold Time, Clock to Data	2.0		-	0	0	0	ns	
		4.5		-	0	0	0		
		6.0		-	0	0	0		
t _W	Minimum Pulse Width Clock,	2.0		30	80	101	119	ns	
	Preset or Clear	4.5		9	16	20	24		
		6.0		8	14	17	20		
t _{TLH} , t _{THL}	Maximum Output Rise and Fall Time	2.0		25	75	95	110	ns	
		4.5		7	15	19	22		
		6.0		6	13	16	19		
t _r , t _f	Maximum Input Rise and Fall Time	2.0		-	1000	1000	1000	ns	
		4.5		-	500	500	500		
		6.0		-	400	400	400		
C _{PD}	Power Dissipation Capacitance (Note 4)		(per flip–flop)	80	-	-	-	pF	
C _{IN}	Maximum Input Capacitance			5	10	10	10	pF	

AC CHARACTERISTICS (CL = 50 pF, $t_r = t_f = 6$ ns (unless otherwise specified))

4. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

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ORDERING INFORMATION

Part Number	Package	Shipping [†]
MM74HC74AM	SOIC-14, Case 751EF (Pb-Free, Halide Free)	55 Units / Tube
MM74HC74AMTC	TSSOP-14, Case 948G-01 (Pb-Free, Halide Free)	96 Units / Tube
MM74HC74AMX	SOIC-14, Case 751EF (Pb-Free, Halide Free)	2500 / Tape & Reel
MM74HC74AMTCX	TSSOP-14 WB, Case 948G-01 (Pb-Free, Halide Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NOTE: Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

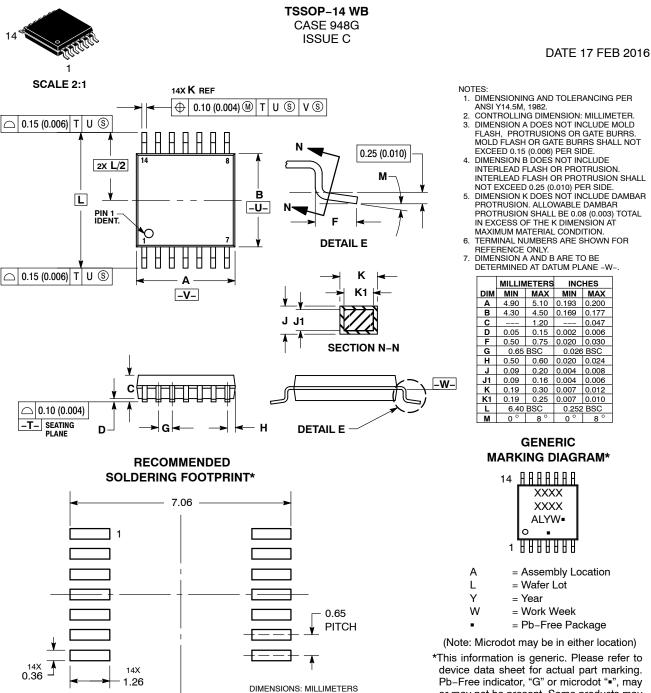
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SOIC14 CASE 751EF **ISSUE O** DATE 30 SEP 2016 8.75 Α 8.50 0.65 7.62 14 8 14 8 В ₽ ╞ 4.00 6.00 5.60 3.80 Ħ = ╞ = Ħ 1.70 7 **PIN #1** 7 1.27 1 0.51 IDENT. 1.270.35 (0.33) - \oplus 0.25 (M) С В Α LAND PATTERN RECOMMENDATION TOP VIEW 1.75 MAX 0.25 0.19 0.10 С 1.50 0.25 1.25 0.10 SIDE VIEW FRONT VIEW NOTES: A. CONFORMS TO JEDEC MS-012, VARIATION AB, ISSUE C **B. ALL DIMENSIONS ARE IN MILLIMETERS** 0.50 0.25 × 45° C. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS R0.10 GAGE D. LAND PATTERN STANDARD: PLANE SOIC127P600X145-14M E. CONFORMS TO ASME Y14.5M, 2009 R0.10 0.36 8° 0° 0.90 0.50 SEATING PLANE (1.04)**DETAIL A** SCALE 16:1

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